

IN RE THE APPLICATION OF

Gangshan XU et al.

Application No. 09/752,509

Filed: December 27, 2000

For: METHODS FOR MAKING
REINFORCED WAFER POLISHING
PADS AND APPARATUSES
IMPLEMENTING THE SAME

Examiner: Not Assigned

Art Unit: 1733

Docket No. LAM2P223A

Date: November 27, 2001

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231 on November 27, 2001.

Signed: _____

Diane Schwanbeck

REQUEST TO RESCIND PREVIOUS NONPUBLICATION REQUEST

35 U.S.C. 122(b)(2)(B)(ii)

Commissioner for Patents
Washington, D.C. 20231

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APR 29 2002

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ORIGINALLY FILED

Sir:

I hereby **rescind** the previous request that the above-identified application not be published under 35 U.S.C. 122(b).

GROUP 1700

Respectfully submitted,
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